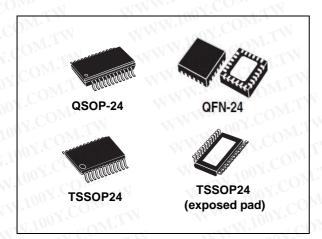


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LED1642GW

16 channels LED driver with error detection current gain control and 12/16-bit PWM brightness control

Datasheet - preliminary data



Features

- 16 constant current output channels
- Output current: from 3 mA to 40 mA
- Current programmable through external resistor
- 7-bit global current gain adjustment in two ranges
- 12/16-bit PWM grayscale brightness control
- Programmable output turn-on/off time
- Error detection mode (both open and shorted-LED)
- Programmable shorted-LED detection thresholds
- · Auto power saving/auto-wakeup
- Selectable SDO synchronization on the CLK falling edge
- Gradual output delay (selectable)
- Supply voltage: 3 V to 5.5 V
- · Thermal shutdown and overtemperature alert
- 30 MHz 4-wires interface
- 20 V current generator rated voltage

Applications

- · Full color/monochrome large displays
- LED signage

Description

The LED1642GW is a monolithic, low voltage, low current power 16-bit shift register designed for LED panel displays. The LED1642GW guarantees 20 V output driving capability allowing the user to connect several LEDs in series. In the output stage, sixteen regulated current sources provide from 3 mA to 40 mA constant current to drive the LEDs. The current is programmed through an external resistor and can be adjusted by 7-bit current gain register in two subranges. The brightness can be adjusted separately for each channel through a 12/16-bit grayscale control.

A programmable turn-on and turn-off time (four different values are available) improves the system low noise generation performances.

In the LED1642GW is available the open/short error detection mode. The auto power shutdown and auto power-on feature (this feature is selectable) allow the device to save power without any external intervention.

Thermal management is equipped with overtemperature data alert and the output thermal shutdown (170 °C). The high clock frequency is up to 30 MHz and it makes the device suitable for high data rate transmission. A selectable gradual output delay reduces the inrush current whereas the selectable SDO synchronization feature works when the device is used in daisy chain configuration. The supply voltage range is between 3 V and 5.5 V.

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Pin description **LED1642GW**

Pin description 1

Figure 1. TSSOP24, TSSOP24EP, QSOP-24 pinout

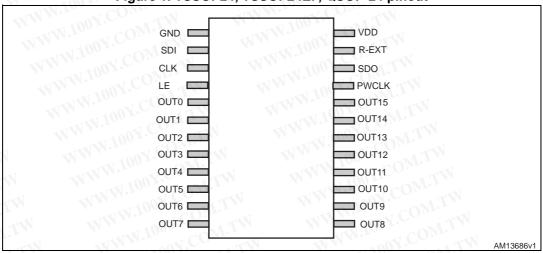


Figure 2. QFN-24 pinout

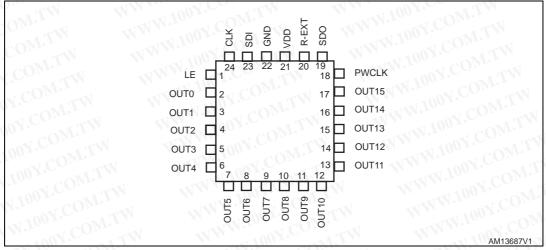


Table 1. Pin description

SSOP24 SSOP24EP QSOP-24	QFN-24	Symbol	Name and function
NY1 10	22	GND	Ground terminal
2	23	SDI	Serial data input terminal
3	24	CLK	Clock input terminal
4	11001	M.T.Y LE	Latch input terminal
5-20	2-17	OUT0-OUT15	Output terminals
21	18	PWCLK	Clock input for PWM counter

TSSOP24 TSSOP24EP QFN-24 **Symbol** Name and function QSOP-24 22 19 SDO Serial data output terminal Terminal for external resistor for constant current 23 20 R-EXT programming 24 21 **VDD** Supply voltage terminal

Table 1. Pin description (continued)

WWW.100Y.COM.TW .COM.TW 2 OM.T **Absolute maximum ratings** WWW.100Y.COM

Stressing the device above the ratings listed in the Table 2 may cause the device permanent damage. Operating under conditions above those indicated in the operating section is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

Table 2. Absolute maximum ratings

V_{DD}	Supply voltage	0 to 7	1007.COV
V _{OUT}	Output voltage	-0.5 to 20	1007.00
Clout	Output current	50	m.
CV_i	Input voltage	-0.4 to V _{DD} +0.4	7.100X.V
I _{GND}	GND terminal current	1400	100 m
ESD	Electrostatic discharge protection HBM human body model	±2	k

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Thermal characteristics **LED1642GW**

3 Thermal characteristics

Symbol	Parameter	aracteristics	Value	Unit
Symbol	N. TOOLS TWO WAY	1007.00	value	Unit
T _a	Operative free-air temperature	e range ⁽¹⁾	-40 to +85	
T _{OPR}	Operative junction temperatu	ire range	-40 to +125	°C
T _{STG}	Storage ambient temperatur	re range	-55 to +150	
OM	WWW.3100Y.COM	QFN-24	30	
COMP	- MAN TOOK COME IN	TSSOP24	85	0000
$R_{thj-amb}$	Thermal resistance junction-ambient	TSSOP24EP ⁽²⁾	37.5	- °C/W
	WWW.100Y.COM. TW	QSOP-24	72	1

This data must be considered in adequate power dissipation conditions, the junction temperature must be maintained below 125 °C. WWW.100Y.COM.T

Electrical characteristics

 V_{DD} = 3.3 V, T_j = 25 °C, unless otherwise specified.

Table 4. Electrical characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
V_{DD}	Supply voltage	MIN TOOK COWITH	3	WW	5.5	OM.	
V _{OUT}	Output voltage	Out 0 - out 15	-	TAN	19		
V _{IH}	Input voltage	M. 1001. COM.1	0.7 x V _{DD}	11/	V_{DD}	$\mathbb{C}^{\mathbb{N}}$	
V_{IL}	- Input voltage	MAN TOOK COM	GND	11	0.3 x V _{DD}		
V _{OL}	Serial data output voltage	V _{DD} = 3 to 5.5 V	T.A.	-	0.4		
V _{OH}	(SDO)	I = +/- 1 mA	V _{DD} -0.4	-	MAN IN		
I _{Oleak}	Output leakage current	V _{OUT} = 19 V, all outputs OFF	W.T.	-	0.5	μΑ	
\/	UVLO threshold (rising)	M. 100 F.	OW.I	2.7	2.9	V	
V_{uvlo}	UVLO threshold (falling)	M. M. M. TOO T.	2.2	2.3	WWW	1700	
Hy _{uvlo}	UVLO hysteresis	1. M. 100 3	CO_{M-1}	400	WIN	mV	

^{2.} The exposed pad should be soldered directly to the PCB to get the thermal benefits. WWW.100Y.COM.TW

Table 4. Electrical characteristics (continued)

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Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Δl _{OL1}	WWW.100Y.COM.TV	$V_{OUT} = 0.1 \text{ V; } (I_{OUT} = 3 \text{ mA})$ $R_{EXT} = 11 \text{ k}\Omega$ CFG-0CFG-5= "000000" CFG-6 = "0"	OM.TW	-	±4	
Δl _{OL2}	Output current precision channel-to-channel (all outputs ON) ⁽¹⁾⁽²⁾	$V_{OUT} = 0.5 \text{ V}; (I_{OUT} = 20 \text{ mA})$ $R_{EXT} = 11 \text{ k}\Omega$ CFG-0CFG-5 = "011010" CFG-6 = "1"	Y.COM.TOM.T	LM M	±3	%
Δl _{OL3}	M MMM.100X.C	$V_{OUT} = 0.8 \text{ V; } (I_{OUT} = 36 \text{ mA})$ $R_{EXT} = 11 \text{ k}\Omega$ $CFG-0CFG-5 = "111111"$ $CFG-6 = "1"$	1700X'CO 100X'CO	W.T.A.	±3	
Δl _{OL2a}	Output current precision device-to-device (all outputs ON) ⁽¹⁾	$V_{OUT} = 0.5 \text{ V}; (I_{OUT} = 20 \text{ mA})$ $R_{EXT} = 1.1 \text{ k}\Omega$ CFG-0CFG-5 = "011010" CFG-6 = "1"	M. 100X	r.co. cōm	TW LT±6	%
%/dV _{OUT}	Output current vs. output voltage regulation (3)	V_{OUT} from 1 V to 3 V; (I_{OUT} = 36 mA) R_{EXT} = 11 k Ω CFG-0CFG-5 = "111111" CFG-6 = "1"	MMM'I	±0.1	OM.TW	N N
%/dV _{DD}	Output current vs. supply voltage regulation ⁽⁴⁾	V_{DD} from 3 V to 5.5 V V_{OUT} = 0.8 V; (I_{OUT} = 36 mA) R_{EXT} = 11 k Ω CFG-0CFG-5 = "111111" CFG-6 = "1"	MM. MMA	±1	OOX.COM	%/V
Rup	Pull-up resistor for PWCLK pin	WWW.100Y.COM.TV	400	500	600	OMIT
Rdw	Pull-down resistor for LE pin	WWW.TOOX.COM	400	500	600	ΚΩ
R _{EXT}	External current setup resistance	MMM.100X.COM	LM.	MA	100	Y.CO
I _{DD} (OFF1)	Supply current (OFF)	R_{EXT} = 11 k Ω OUT 0 to 15 = OFF CFG = default	M.TW M.TW	- 1/1	6	DOX.CO
I _{DD} (ON1)	- Supply current (ON)	$R_{EXT} = 11 \text{ k}\Omega; I_{OUT} = 20 \text{ mA}$ OUT 0 to 15 = ON CFG-0CFG-5 = "011010" CFG-6 = "1"	OM.TW COM.TW		8	mA
I _{DD} (ON2)	очрру очнен (Ом)	$R_{EXT} = 11 \text{ k}\Omega; I_{OUT} = 36 \text{ mA}$ OUT 0 to 15 = ON CFG-0CFG-5 = "111111" CFG-6 = "1"	ov.com	EW EW	10	NWN.

NWW.100Y.COM.TW **Electrical characteristics LED1642GW**

Table 4. Electrical characteristics (continued)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I _{DD} (auto OFF)	Supply current (auto OFF)	R_{EXT} = 11 kΩ; OUT 0 to 15 = OFF CFG-0CFG-5 = "111111" CFG-6 = "1"	OM.TW COM.TW	200	500	μA
T _{flg}	Thermal flag	IM MM. 1001	COM.T	150		
T _{sd}	Thermal shutdown	VI.TW WW. 100	MO	170		°C
T _{sd-hy}	Thermal shutdown hysteresis	MIM WWW.10	OY.COM	15	20	

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- 1. Tested with just one output loaded.
- 2. ((loutn loutavg1-15)/ loutavg1-15) x 100.

WWW.103. WWW.toox.COM

2. ((loutn - loutavg1-15)/ loutavg1-15) x 100.
3.
$$\Delta(\%/V) = \frac{(\text{Ioutn @ Voutn} = 3.0V) - (\text{Ioutn @ Voutn} = 1.0V)}{(\text{Ioutn @ Voutn} = 1.0V)} \times \frac{100}{3-1}$$
4.
$$\Delta(\%/V) = \frac{(\text{Ioutn @ V dd} = 5.5V) - (\text{Ioutn @ V dd} = 3.0V)}{(\text{Ioutn @ V dd} = 3.0V)} \times \frac{100}{3-1}$$

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4.
$$\Delta(\%/V) = \frac{(\text{Ioutn @ V dd} = 5.5V) - (\text{Ioutn @ V dd} = 3.0V)}{(\text{Ioutn @ V dd} = 3.0V)} \times \frac{100}{5.5 - 3}$$

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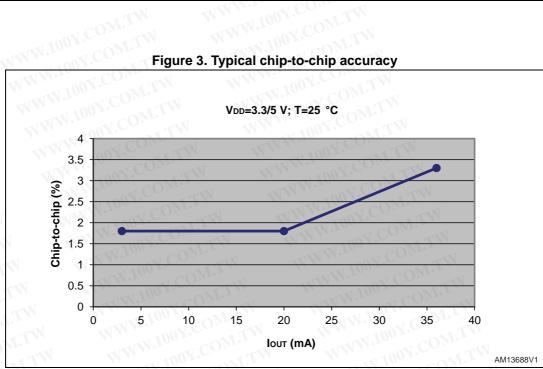
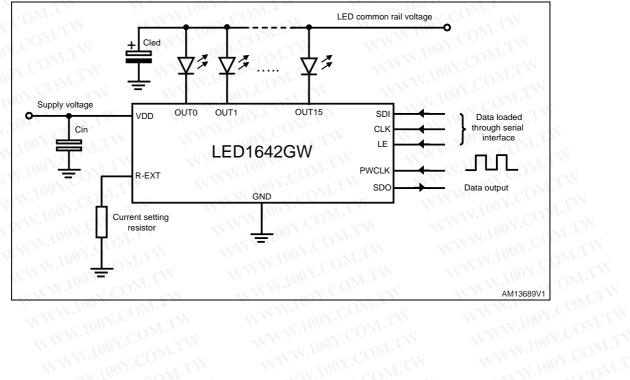


Figure 3. Typical chip-to-chip accuracy





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Switching characteristics 5

 $V_{DD} = 3.3 \text{ V}, T_i = 25 ^{\circ}\text{C}, \text{ unless otherwise specified.}$

Table 5. Switching characteristics

Symbol	Par	ameter	Conditions	Min.	Тур.	Max.	Unit
f _{clk}	Clock	frequency	Cascade operation	W	-	30	N 41 1-
f _{pwclk}	PWclock	k frequency	MMM.Ing.COU	TV	-	30	MHz
tr _(SDO)	SDO	rise time	R_{EXT} = 11 kΩ; I_{OUT} = 20 mA V_{OUT} = 0.8 V	DM.T	5	-	
tf _(SDO)	SDO	fall time	VIH = V_{DD} ; VIL = GND RL = 3.3 K Ω ; CL = 10 pF CFG-0CFG-5 = "011010" CFG-6 = "1"	COM:	5	-	
tPLHLE	LE - OUTn ⁽¹⁾	Propagation delay	M. I.A. M. M. M. Too	V.CC	200	- N	
tPLH	CLK - SDO CFG-13 = '0'	time ("L to "H")	L to "H") gation delay time H" to "L") $R_{EXT} = 11 \text{ k}\Omega; I_{OUT} = 20 \text{ mA}$ $V_{OUT} = 0.8 \text{ V}$	8 C	15	25	
tPHLLE	LE - OUTn ⁽¹⁾	Propagation delay		100,	100	U.L.	
tPHL	CLK - SDO CFG-13 = '0'			8	15	25	ns
tw(CLK)	CLK	WWW.101		20	01-c	071.7	W
t _W (PWCLK)	PWCLK	Pulse width		20	007.	Mo	IM
tw(L)	N. C. O. C.	MM	$RL = 50 \Omega$; $CL = 10 pF$	20	1001	~ - 01	TW
t _{gr-d}	Gradual d	elay ch-to-ch	CFG-0CFG-5 = "011010"		10	(0	M.T
t _{su(L)}	Setup t	ime for LE	CFG-6 = "1"	5	W-10) Y	OM.T
t _{h(L)}	Hold ti	me for LE		5	JV.1	007.	MO
t _{su(D)}	Setup ti	me for SDI		5	W.	100_{J}	COD
t _{h(D)}	Hold tir	me for SDI		10	TAN V	160x	-c0
tclkr ⁽²⁾	Maximum	CLK rise time		-	N T	5	116
tclkf ⁽²⁾	Maximum	CLK fall time	WW.100Y.COM.TW	-	M. A.	5	μs
I _{out-ov}	Output current turn-on overshoot $V_{OUT} = 0.6 \text{ to } 3 \text{ V}$ $CL = 10 \text{ pF; } I_{OUT} = 3 \text{ to } 36 \text{ mA}$	-	W	10	%		
t _{n-err}	7	ror detection utput ON time	WWW.100Y.COM.T	N	- 1	1	μs
t _{shutdown}	Auto power shutd	own time (auto OFF)	From LE falling edge to R _{EXT} voltage reference at -10%	TW	100	MM	ns
t _{wakeup}	Auto	-wakeup	From LE falling edge to R _{EXT} voltage reference at 90%		3	-41	μs

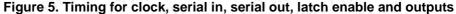
^{1.} CFG -11= 0 and CFG -12 = 0 (output tr = 30 ns; output tr = 20 ns); CFG-14=1 (no output gradual delay).

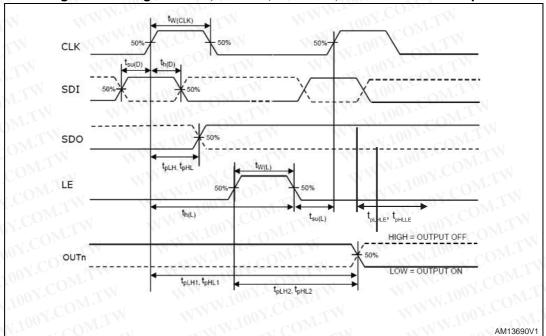
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^{2.} If devices are connected in cascade and tclkr or tclkf is large, it may be critical to achieve the timing required for data transfer between two cascaded devices.

Configuration bits	Conditions	Typ. (20%	% to 80%)	Unit
(CFG-12 - CFG-11)	Conditions	Turn-on	Turn-off	Onit
0 - 0	$R_{EXT} = 11 \text{ k}\Omega; I_{OUT} = 20 \text{ mA}$	30 ns	20 ns	
TW 0-1 WWY	$V_{OUT} = 0.8 \text{ V}$	100 ns	40 ns	
1-0	VIH= V_{DD} ; VIL= GND RL = 50 Ω; CL=10pF	140 ns	80 ns	ns
M.TW1-1	CFG-6 - "1"	180 ns	150 ns	

Table 6. Programmable T_{ON}/T_{OFF} (output rise and fall time)





The correct sampling of the data depends on the stability of the data at SDI on the rising edge of the clock signal and it is assured by a proper data setup and hold time ($t_{SU(D)}$) and $t_{h(D)}$), as shown in *Figure 5*. The same figure shows the propagation delay from CLK to SDO (t_{PLH}/t_{PHL}). *Figure 5* describes also the minimum duration of CLK, LE pulses ($t_{W(CLK)}$) and $t_{W(L)}$ respectively and the propagation delay from LE to OUT_n (t_{PLHLE} and t_{PHLLE}) in the hypothesis that all channels have already been enabled by PWM counter.

6 Simplified internal block diagram

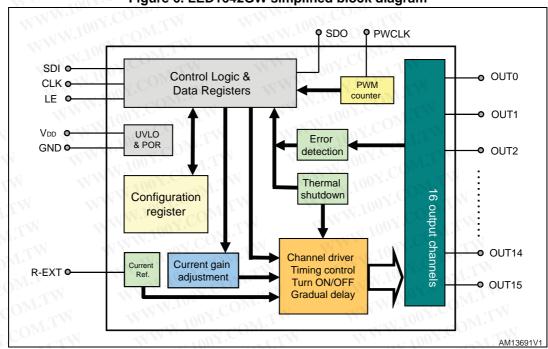


Figure 6. LED1642GW simplified block diagram

6.1 Equivalent circuits of inputs and outputs

LE and PWCLK input terminals have pull-down and pull-up connection respectively. CLK and SDI must be connected to the external circuit to fix the logic level.

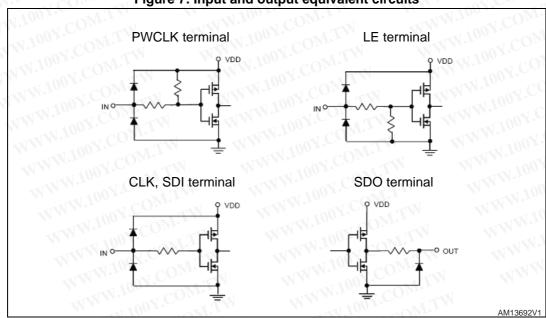


Figure 7. Input and output equivalent circuits

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LED1642GW Digital blocks WWW.100 Y.CO

7 **Digital blocks**

WWW.100Y.COM.TW The data input arrives through the serial Interface at each CLK rising edge. The LE signal is used to latch the loaded data and also to address data loading to the appropriate register, thermal flag reading and error detection. The access to the different registers or functions of the device (configuration register, brightness register or current gain, error detection, etc.) is achieved by using different digital keys, defined as a number of CLK pulses during which the LE signal is asserted. The available digital keys are listed in Table 7 and Figure 8. A typical channel data input is shown in Figure 9.

Number	# CLK rising edge when the LE is "1"	' Command description
1	1-2	Write switch (to turn on/off output ch
2	3-4	Brightness data latch
3	5 – 6	Brightness global latch
4	WWW.TW.CO.M.TW	Write configuration register
5	80Y.CO.TW	Read configuration register
6	9,007.00	Start open error detection mode
7	10	Start short error detection mode
8	W 11 100X	Start combined error detection mode
. 9	12	End error detection mode
10	TW 13	Thermal error reading
11	14 100Y	Reserved
12	15 NOV.	Reserved

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Digital blocks LED1642GW

Figure 8. Digital keys

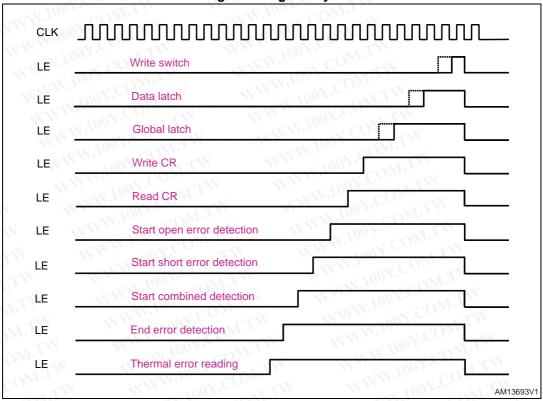
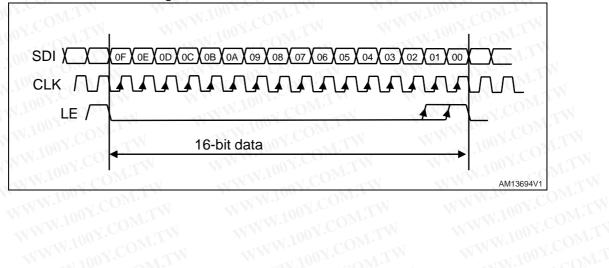


Figure 9. Channel data and write switch



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8 **Configuration register**

The configuration register is used to enable or disable some device features, to program some parameters and to change other settings. The access to this register (read or write) is managed to find a description for each bit as described in Table 8. The default value of the configuration register (when the device is switched on or after a reset) is "0" for all bits. To change anything in the configuration register, a 16-bit digital word must be sent (CFG - 0 represents LSB, CFG -15 the MSB).

Bit	Definition	R/W	COMITW	Desc	ription			Default
CFG-0	N N	W.100	COMIT	COM. TOWN TOWN TOWN TOWN TOWN TOWN TOWN TOWN			I.I.	0
CFG-1			6-bit DAC allows adjusting the device output current in 64				0	
CFG-2	Current gain	R/W					ent in 64	0
CFG-3	adjustment	R/VV	steps for each range (defined by CFG-6)				0	
CFG-4	MI.TW		100X. COM.TV					0
CFG-5	M.TW		W.100Y. COM.T	100X.COM.TW WW.100X.COM.T				
CFG-6	Current range	R/W	"0" low current rang	W	MN.100	Y.COM.	CW 0	
CFG-7	Error detection mode	R/W	"0" normal mode "1" reserved mode				0	
MMira	I.COM		R/W Programmable output shorted-LED detection thresholds	VTI	CFG-9	CFG-8	Th. volt.	WIIN
CFG-8	Shorted-LED	R/W		out X	0	0	1.8 V	0
	detection				0	1 1	2.5 V	OM.T
050.0	thresholds	DAM		hresholds 1 0 3 V	3 V	CO1.T		
CFG-9	Too X COM	R/W	WWW.100		111	1	3.5 V	.CCO
CFG-10	Auto OFF shutdown	R/W	"0" device always C	ice always ON o power shutdown active (auto OFF)				001
- 1	M. M. Jon	M.,	NMM')	CFG-12	CFG-11	Turn-on	Turn-off	ONY.CO
CFG-11	WW.100 P	R/W	Programmable	0	0	30 ns	20 ns	0.0
	Output turn- on/off time		output rise and fall	0	ClO _M	100 ns	40 ns	.100X.
050.40		COM.	time (20% to 80%)	1.30	0	140 ns	80 ns	100X
CFG-12	MAM. 100 .	R/W		1	1.CON	180 ns	150 ns	W.30
CFG-13	SDO delay	R/W	If "0" no delay is pre If "1" the data are sl the falling edge of the	nifted out	and they a	are synchr	onized with	0

Bit	Definition	R/W	Description	Default
CFG-14	Gradual output delay	R/W	"0" a progressive delay is applied to output (10 ns per channel) "1" no delay is applied to output	0
CFG-15	12/16 PWM counter	R/W	"0" to select 16-bit brightness register (65536 grayscale rightness steps). "1" to select 12-bit brightness register (4096 grayscale brightness steps)	0

Table 8. Configuration register (continued)

8.1 Gain control (from CFG 0 to 5) and current ranges (CFG- 6)

The LED current can be programmed using an external resistor connected to GND from R_{EXT} pin and can be fixed using the dedicated bits of the configuration register (from CFG - 0 to CFG - 5 bits define the gain, while CFG - 6 bit defines the current range within the which the gain can be adjusted). The device can regulate the current up to 36 mA and down to 0.5 mA. The accuracy of the LED current depends on the selected range and it is guaranteed in the ranges indicated in the static electrical characteristics only (see *Table 3* and *9*). When the device is switched on, the selected current range and the resistor connected to the R_{EXT} pin fix the default LED current:

$$I_{OL_default} = \frac{V_{REF}}{R_{EXT}} \cdot K$$

Where V_{REF}=1.23 V is the voltage of the R_{EXT} pin and K is the mirroring current ratio, whose value depends on the selected current range:

- K = 28 with low current range selected (CFG 6 = "0")
- K = 80 with high current range selected (CFG 6 = "1")

The relation between the programmed current and the current gain settings is the following:

$$I_{\scriptscriptstyle OL} = (I_{\scriptscriptstyle OL_default} + G \cdot \Delta I_{\scriptscriptstyle step})$$

where G is the current gain value (decimal value) defined by the dedicated bits of the current gain register. The current gain is managed by 6-bits of the configuration register (CFG - 0 to CFG - 5, CFG - 0 is LSB and CFG - 5 is MSB) and can be adjusted within two ranges (selectable through the bit CFG - 6) over 64 steps. The width of each step depends on the default current ($I_{ol_default}$) as well as the selected R_{EXT} . Finally, each step is as follows:

$$\Delta I_{step} = \frac{I_{OL_default}}{21}$$

The *Table 9* shows an example of the current setting with an external resistance (R_{EXT}) = 11 $K\Omega$:

		Tubic 3	Example of barr	chi runges	
W	R _{EXT} [KΩ]	CFG-6	CFG-0 to CFG-5	LED current ⁽¹⁾ [mA]	Accuracy
L ou rongo	11	00	000000	3.1 mA	± 4% ch-to-ch
Low range	W 111	CO	111111	12.5 mA	
Cilula namana	11.100	V.CDM	000000	8.9 mA	N
High range	11	10	011010	20 mA	± 3% ch-to-ch

Table 9. Example of current ranges

The *Table 10* shows an example of current setting and gain control with $R_{EXT} = 11 \text{ k}\Omega$, see also *Figure 10*.

	CFG-6	CFG(0 to 5)	LED current ⁽¹⁾ [mA]
COMITW	WWW OOY.CO	000000	3.131
Y.COM	0 001	000001	3.280
Low range	MMM. 100X'CO	WITH W	W. 100X:COM.T
	MM 0 100 X.C.	111111	12.524
100Y.COMLTV	W 1 100 X.C	000000	8.945
High range	V 1 100Y	000001	9.371
High range	IM MM 100	Y.COM.T.N	MM. 100 Y.Co
	1/1/1/100	111111	35.78

Table 10. Gain steps for the current range selected by $R_{EXT} = 11 \text{ k}\Omega$

The external programming resistance must be connected as close as possible to the related device pins (R_{EXT} and GND) to reduce as minimum as possible the routing length and prevent reference noise injection and electromagnetic interferences. Moreover, a direct connection to the device GND pin reduces the possible output current variation when the total device ground current changes (load effect).

^{1.} The indicated values may be slightly different on the current device.

^{1.} The indicated values may be slightly different on the current device.

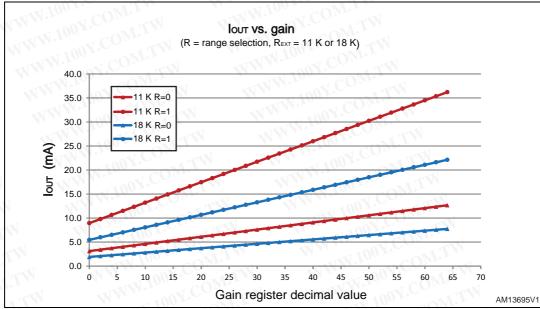


Figure 10. Channel current vs. gain register value

8.2 Error detection mode (CFG-7)

Stopping the normal activity of the display and turning on all driver channels allows the error detection to be performed and failed LED or display defects to be checked.

The error detection is active when the CFG -7 bit of the configuration register is "0". The diagnostics is performed as shown in *Figure 11*:

- The LED has to be selected turning on the relative channel on the switch register (powering on or off the output channels); the brightness register value for this channel cannot be zero.
- The normal error detection has to be selected in the configuration register (CFG-7= "0"). The appropriate digital key to choose the type of detection (open, short or combined) must be sent (see *Table 7*).
- After the error detection starts, the channel under testing has to be turned on at least 1 μs (the LED is at the nominal current). Please note that, the output power-on depends on PWCLK signal and in several applications this signal is not synchronized with the serial interface clock (CLK pin). Therefore, to be sure that, between the detection start and the detection end, the output power-on is 1 μs and moreover, that last power-on, in the interval, starts at least 0.5 μs before the detection end pattern (see *Figure 12*), it is suggested that the error detection should be performed just after the device startup (brightness counter reset) with all channels ON, before applying PWCLK signal.
- The result of the detection ("0" indicates a fault condition) is shifted out SDO, in 16 clock pulses after the "detection end command" is provided, first output bit represents channel 15 (error data can be read in a way similar to configuration register data reading as shown on *Figure 13*, *14*, *15* and *16*).

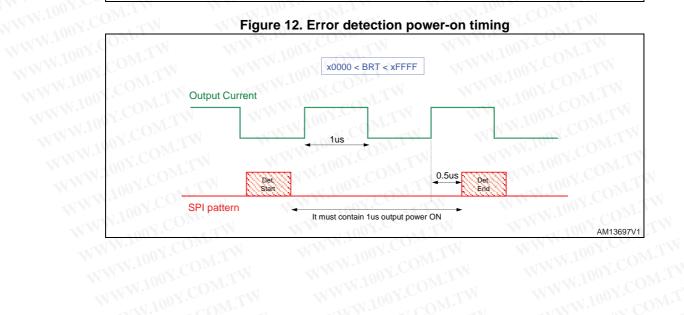
Please note that (with SDO delay off) output 15 detection result will be available just after 1st clock pulse rising edge, so it can be sampled on the rising edge of second clock pulse. In the same way output 0 detection result will be available just after 16th clock pulse rising edge, so it can be sampled on the rising edge of 17th CLK pulse.

WWW.100Y.COM Normal detection sequence Select LED to be turned on and checked in switch register data; brightness for selected channels cannot be zero. Select normal error detection mode on CFG register (bit 7 = "0") Send open, short or combined error detection start command by LE digital keys Turn on LED by PWCLK pulses for at least 1 us Send error detection end command by LE digital key W.100Y.COM.TW Read error detection result on SDO in 16 clock pulses after detection end command AM13696V1

Figure 11. Error detection action sequence

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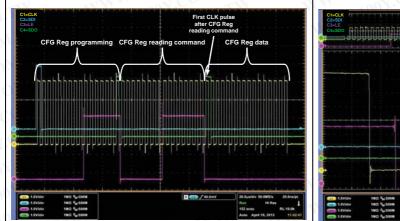


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Configuration register LED1642GW

Figure 13. Configuration register reading sequence

Figure 14. Configuration register reading sequence (zoom)



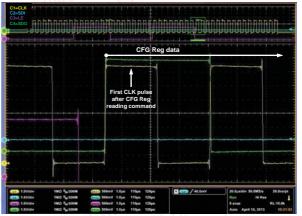
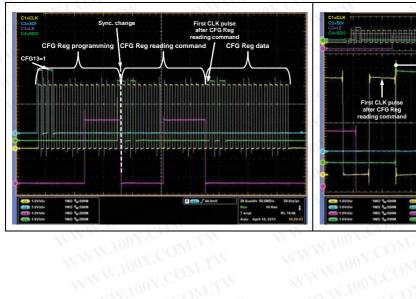
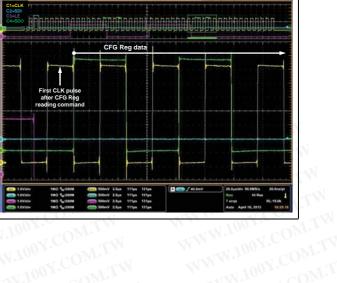


Figure 15. Configuration register reading sequence - SDO delay actives

Figure 16. Configuration register reading sequence - SDO delay actives (zoom)





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8.3 Error detection conditions

During the error detection phases for each channel, the following checks have to be performed:

- The output current in open detection mode (digital key: 9 CLK rising edges when LE is "1")
- The output voltage in short detection (digital key: 10 CLK rising edges when LE is "1")
- Both parameters (output voltage and current) in combined error detection mode (digital key: 11 CLK rising edges when LE is "1").

The thresholds for the error diagnostics are listed in *Table 11*:

Error dete	ction	Checked	050.0	050.0	N.1003	Thresholds (V)	
mode	s W	malfunction	CFG-9	CFG-8	Min.	Тур.	Max.
Open detection	mode	Open line or output short to GND	X	x W	NW.	I _{OUT} ≤ 0.5 x I _{OUT} programmed	-
OWITW	_	M. 1003 CO	0	0	1.15	V _{OUT} ≥ 1.8	2.05
Short	bine	Short on LED or short	0 0	. 1	2.25	V _{OUT} ≥ 2.5	2.75
detection	Sombined	to V-LED	OM.	0	2.75	V _{OUT} ≥ 3.0	3.25
COM.T	-XI	M. 1. 100 J.	$CO^{1/1.3}$	1	3.25	V _{OUT} ≥ 3.5	3.80

Table 11. Diagnostic thresholds

8.4 Auto-wakeup/auto power shutdown (CFG-10)

This feature reduces the power consumption when all outputs are OFF. It is active when the CFG -10 bit of configuration register is "1". The auto power shutdown (auto OFF) starts when the data latched is "0" for all channels, and device is active again (wakeup) at the first latched data string including at least one bit = "1" (at least one channel ON). Timings for shutdown and wakeup are present in the dynamics feature table. While the auto power shutdown is active, the device ignores any other command except the channel power-on.

8.5 Programmable turn-on/turn-off time (CFG-11/12)

The device gives the possibility to program the turn-on and turn-off time of the current generators. Four different values can be selected using CFG -12 and CFG-11 bits of the configuration register (see *Table 8*) to fit the application requirements: 30/20 ns (00), 100/40 ns (01), 140/80 ns (10) and 180/150 ns (11). The selected value refers to T_{ON} (current rise time) and T_{OFF} (current fall time).

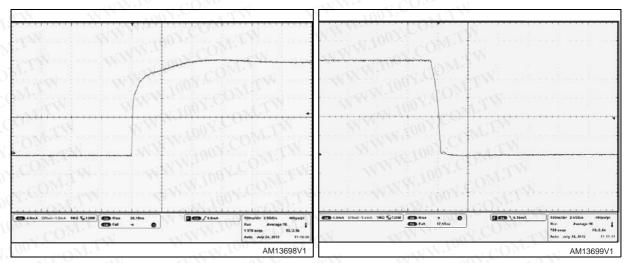
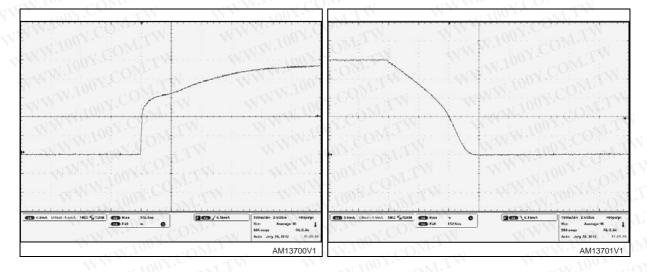


Figure 17. Output T_{ON} (current rise time) CFG - Figure 18. Output T_{OFF} (current fall time) CFG - 12 = CFG - 11 = 0

Figure 19. Output T_{ON} (current rise time) CFG - Figure 20. Output T_{OFF} (current fall time) CFG - 12 = CFG - 11 = 1



8.6 SDO delay (CFG-13)

Usually in SDO terminal, data are shifted out the rising edge of CLK signal (with a propagation delay of about 15 ns - signal (a) in *Figure 21*). The device has the possibility to shift data out the falling edge of the CLK signal (with few ns of propagation delay - signal (b) in *Figure 21*). This feature is active when CFG -13 bit of the configuration register is "1". Default setting for this bit is "0" hence the SDO delay is not activated by default. This feature is particularly useful when some devices are connected in daisy chain configuration with mismatched propagation delays, between CLK and SDO data path (board routing).

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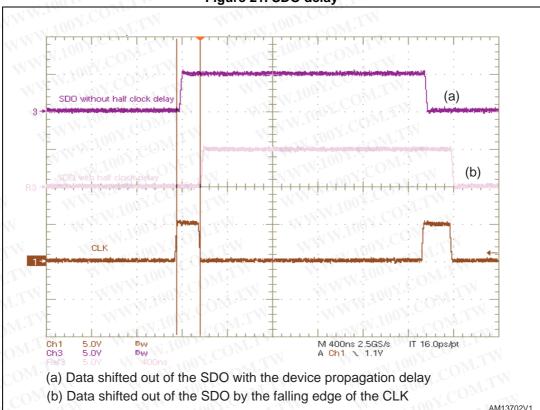
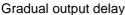


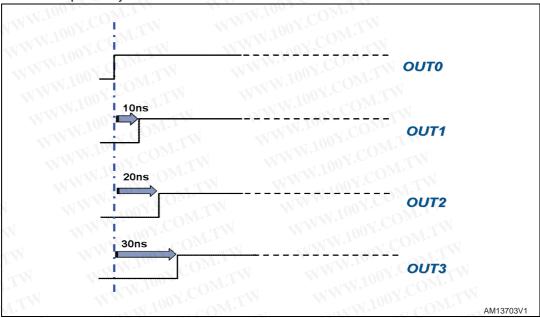
Figure 21. SDO delay

8.7 Gradual output delay (CFG-14)

The gradual output delay consists of turning on gradually the current generators avoiding to turn on all channels at the same time.

When PWM counter enables the device channels, the outputs can be turned on simultaneously or with a progressive delay. Thanks to configuration register CFG -14 bit, the user can decide to put a delay among outputs (10 ns from each channel to the next one, around 150 ns between first and last channel). The typical output timing is shown in *Figure*. This feature prevents the inrush current and reduces the bypass capacitor value.





8.8 PWM counter setting and brightness register (CFG-15)

The brightness of each channel can be adjusted through a 12/16-bit PWM grayscale brightness control according to the PWM counter selection (configuration register CFG -15 bit). Brightness data is loaded by the SDI pin in a 16-bit shift register. Once 16-bit has been loaded (first input bit of brightness word is MSB, 16th bit is LSB), the digital word is moved to the corresponding temporary buffer (first word is the brightness of channel 15, the last one is for channel 0) using the appropriate key shown in *Table 7* ("data latch"). One "data latch" key must follow each 16-bit brightness word except the last one. When the last brightness word is loaded (channel 0 brightness data), the key indicated as "global latch" in *Table 7* must be used. This action moves the word from the shift register to the temporary buffer through the OUT0 and, at the same time, transfers all data of the 16 temporary buffers (16 x16-bit string) to the corresponding brightness registers (see also *Figure 27*).

The PWM signals are generated by comparing the content of the brightness registers to a 16-bit or 12-bit counter, according to the CFG-15 bit status. The counter's clock source is provided to the PWCLK pin. In case of selection of 12-bit PWM counter, the four most significant bits of each brightness data word are ignored. However, each of sixteen brightness data words must be 16-bit long. The brightness register default value is "0", unless this value is changed, the LED brightness is minimum. *Figure 26* shows this function in the schematic.

PWCLK must be a square wave signal, duty cycle is not important but the minimum width has to be above 20 ns, max. frequency has to be 30 MHz (pay attention the minimum output ON time). Just after the device startup (brightness counter reset), before applying PWCLK signal, all channels are in power-on condition if the brightness register values are not zeroed.

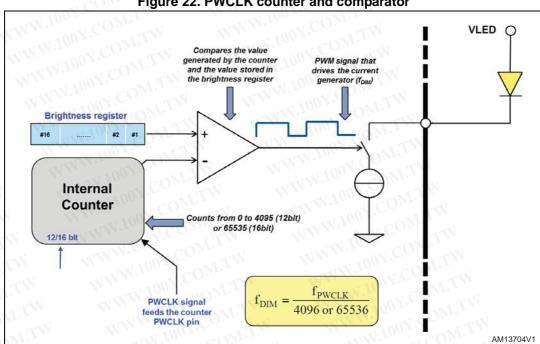
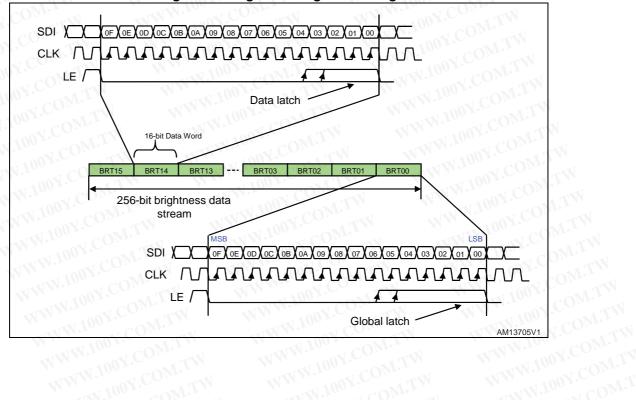


Figure 22. PWCLK counter and comparator

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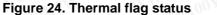
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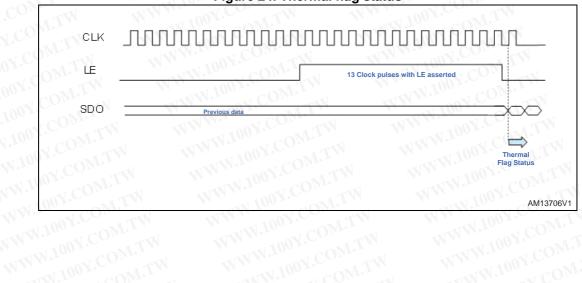
Thermal flag LED1642GW

9 Thermal flag

The device has a thermal control logic providing a flag status when the internal temperature exceeds 150 °C (if temperature increases over 170 °C a thermal shutdown protects the device). This status can be read running the digital key "thermal error reading", holding the LE high for 13 CLK rising edges (see *Figure 24*). If thermal alert is asserted, a 16-bit string = "1" is sent by SDO. The error data is uploaded into EDR register and this error notification is ready to be streamed through SDO to next 16 CLK rising edges. Hence, thermal flag status can be:

Device temperature	SDO
under 150 °C	"0000 0000 0000 0000"
over 150 °C	"1111 1111 1111 1111"





LED1642GW Dropout voltage

10 **Dropout voltage**

In order to correctly regulate the channel current, a minimum output voltage (V_{DROP}) across each current generator must be guaranteed.

The Figure 25 and Table 12 show the minimum V_{DROP} related to the regulated current; these measurements have been recorded with just one output ON. When more than one output is active the drop voltage increases. At 36 mA per channel, the minimum output voltage must be increased about 200 mV.

A V_{DROP}, lower than the minimum recommended, implies the regulation of a current lower than the expected one. However an excess of V_{DROP} increases the power dissipation.

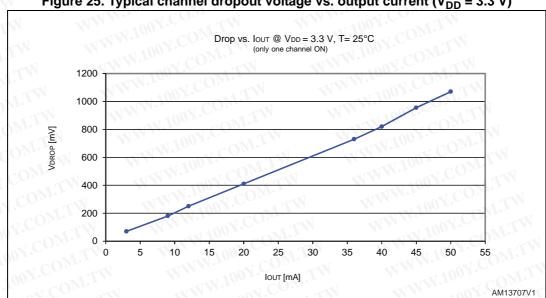


Figure 25. Typical channel dropout voltage vs. output current (V_{DD} = 3.3 V)

Table 12. Minimum dropout voltage for some current values

Y. COOY.	3	N WY	1001	.Co. TY	70	N 100X	
W.100Y	.00 9	W W	WW. 100	Y.COM.T	180	WW 100	Y.C
MW. 100	12	TW V	V 100	O.Y.CO.M.	250	NW 10	O.Y.
NWW	20	IV	MM	OON.CO	410	WWW	00X
WWW	36	TW	MAN	100 X.Co.	730	WWW	100
MMM	40	WEIM	MAN	100Y.Co	820	WW	1.10
MMM	45	M.TW	MMA	M 100 Y.Ce	955	MM	w.1
WW	50	WTI	MM	100Y.C	1070	MAN	- X X

Package mechanical data 11

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Table 13, QSOP-24 mechanical data

Dim.	Min.	Тур.	Max.
A	1.54	1.62	1.73
A1	0.1	0.15	0.25
A2	ON. CONI.TVI	1.47	M. T.
b	0.31	0.2	OM
C WWW	0.254	0.17	COM
D NW	8.56	8.66	8.76
M. E WY	5.8	6	6.2
E1	3.8	3.91	4.01
е	M.M. Too. COM.	0.635	OUN.COM
COM.	0.4	0.635	0.89
COM h	0.25	0.33	0.41
A COM	8° CO	0°	N.P. CO

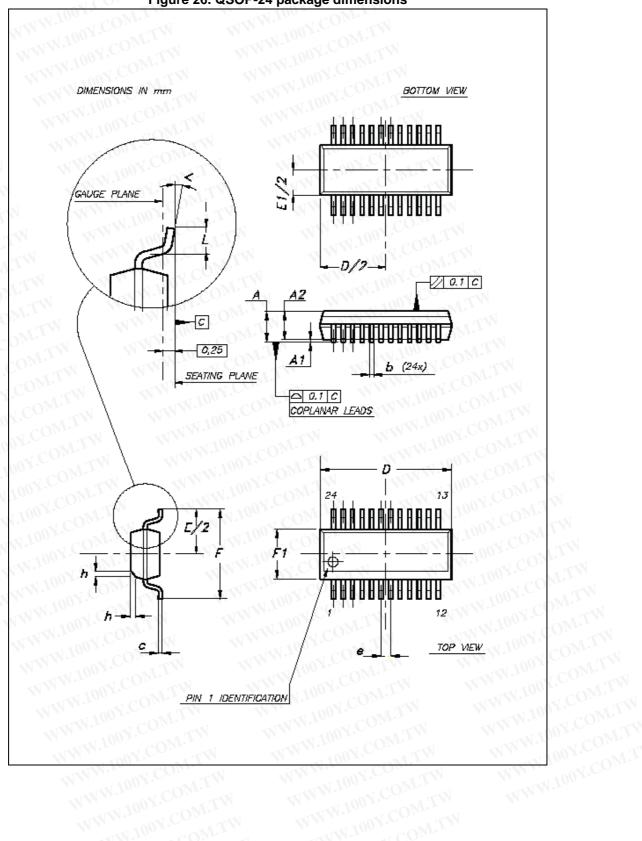


Figure 26. QSOP-24 package dimensions

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WWW.100Y.COM.T

Table 14. QFN-24 mechanical data

WWW.100Y.COM.TW

on.COM.TW

Dim.	N. T.	CONTRACTOR				
WW 1007.Co	Min.	Typ.	Max.			
A OOX	0.80	0.90	1.00			
A1 00 Y	M.TW O WY	0.02	0.05			
A3	ON.TW W	0.20				
W b 1008	0.18	0.25	0.30			
WD 100	3.85	4.00	4.15			
D2	2.00	2.15	2.25			
N EVN	3.85	4.00	4.15			
E2	2.00	2.15	2.25			
TW e WWY	100Y.COM.TW	0.50	MIM			
CTW L WW	0.30	0.40	0.50			

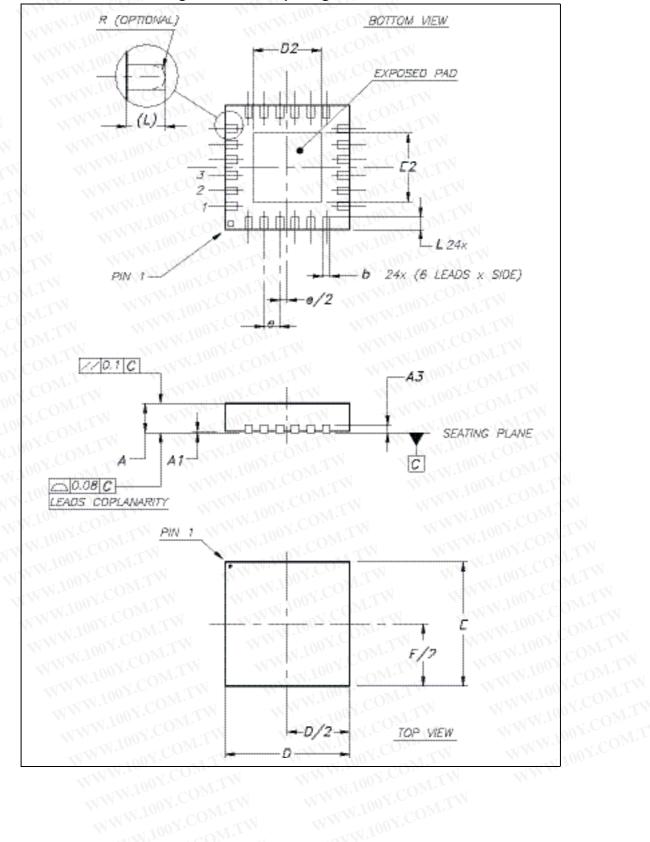


Figure 27. QFN-24 package dimensions

WW.100Y.COM.TW

WWW.100Y.COM.T

Table 15. TSSOP24 mechanical data

NWW.100Y.COM

VWW.Inv.COM.	CM MMM'	TW WWW.			
WWW.Dim.	Min. WWW	Тур.	Max		
A OOY.	WITH WITH	N 100Y.COM.TW	1.1		
A1	0.05	TV 100Y.COM.TW	0.15		
A2	OM.TW W	0.9			
Mp 100X.c	0.19	W. 100Y.COM.T	0.30		
W C 100Y	0.09	W. 1007. COM	0.20		
D 100	7.7	MM. 1007.00M	7.9		
E 100	4.3	WW.1007.CC	4.5		
e	OX.CO.M.TW	0.65 BSC	M.TW		
TW HWW	6.25	MM. 100X.C	6.5		
TW K WW	0°	M.M. 100X.	8°		
TW L WWW	0.50	MM 100X	0.70		

Figure 28. TSSOP24 package dimensions

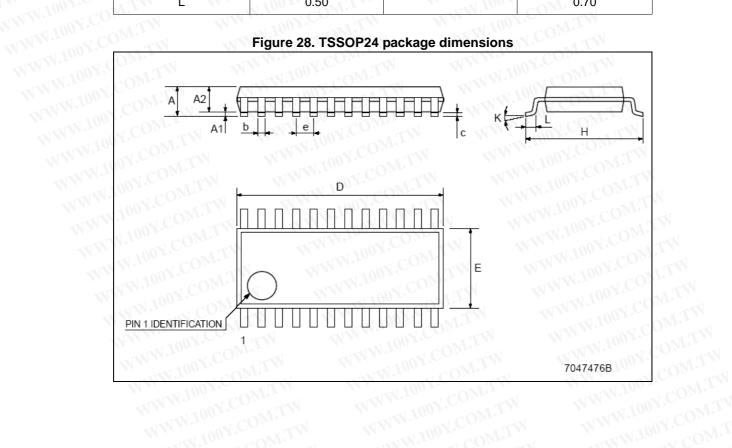


Table 16. TSSOP24 exposed pad mechanical data

NWW.100Y.COM.TW

Dim.	TOWN WWW.C. MM TW				
WWW.DIII.	Min. WWY	Тур.	Max		
A OOY.	WILW WIL	TALLOON.COM.TV	1.20		
A1 00 1	OM.TW WY	W.100Y.COM.T	0.15		
A2	0.80	1.00	1.05		
W/b 1007	0.19	NW. 100Y. COM	0.30		
WC 100	0.09	WW. 1007.001	0.20		
DN	7.70	7.80	7.90		
D1	2.70	WW.1007.6	OWITW		
M ENW	6.20	6.40	6.60		
E1 W	4.30	4.40	4.50		
TW E2 WW	1.50	WW.1007	TIMO		
cTW e WW	V 100Y.COM.TW	0.65	T. M.T.		
WIN L W	0.45	0.60	0.75		
LI WI	W 100Y.COM.T	1.00	OUT. COMIT		
M.T.Wk	WW. 1000	LW WALL	1107.		
aaa	AMA TOOLICE	IN WA	0.10		

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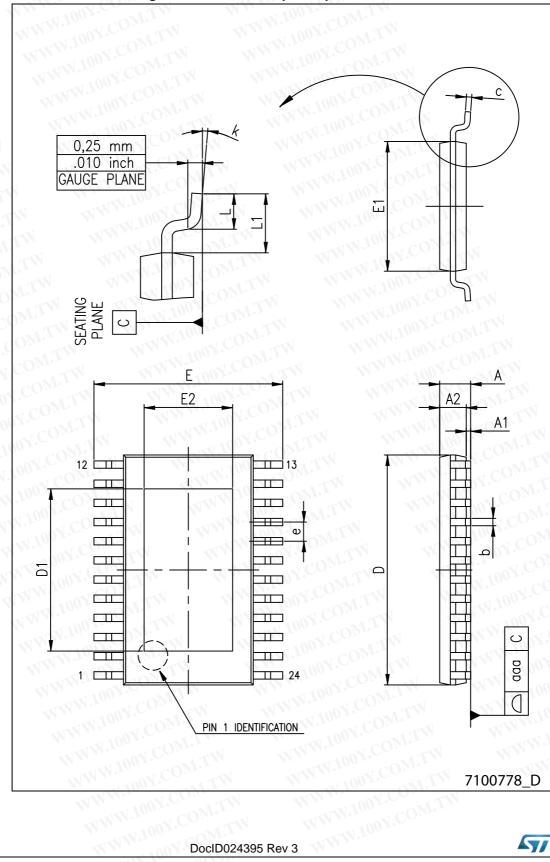


Figure 29. TSSOP24 exposed pad dimensions

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Packaging mechanical data 12

Table 17. TSSOP24 and TSSOP24 exposed pad tape and reel mechanical data

WW.100Y.COM.TW

Dim.	WITH WWW.1007 mm M.TW		
MM PHIL	Min.	Typ.	Max.
A 100	ONT	MAN Jun COM.	330
C 1,100	12.8	M.M. Ton - COM.	13.2
D 100	20.2	MANATON COMP	TW
N 100	60	MAN TON CON	
T 7 10	COMI	TWW.100 CO	22.4
Ao	6.8	ALMA TOO ST.CO	7
Во	8.2	MAN JOS C	8.4
Ko	1.7	MAN. 100	1.9
Po	3.9	I WW.IOO	CO 4.1
P	11.9	-WW.100	12.1

WWW.100Y.COM.T

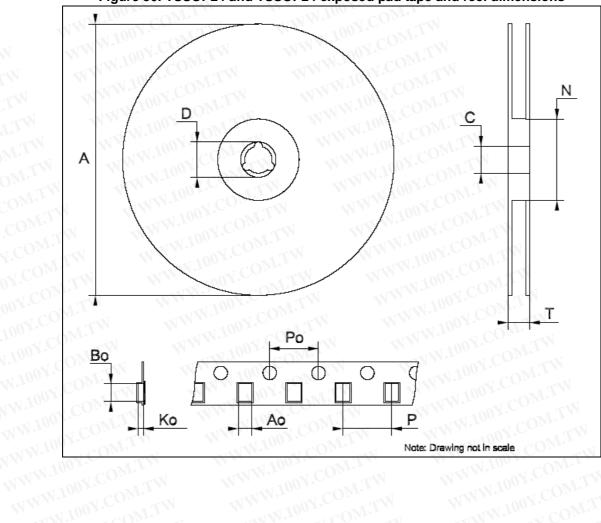


Figure 30. TSSOP24 and TSSOP24 exposed pad tape and reel dimensions

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WWW.100Y.COM.TW Ordering information 13 WWW.100Y.CC

WWW.100X.COM.TW **Table 18. Ordering information**

NWW.100Y.COM.TW

Order code	Package	Packaging
LED1642GWPTF	QSOP-24	2500 parts per reel
LED1642GWQTF	QFN-24	4000 parts per reel
LED1642GWTTF	TSSOP24	2500 parts per reel
LED1642GWXTT	R TSSOP24 exposed pad	2500 parts per reel

NWW.100Y.COM.TW iony.COM.TW **Revision history LED1642GW** WWW.100Y.CO

WWV

Revision history 14

WWW.100Y.COM.TW 100Y.COM.TW Table 19. Document revision history

Date	Revision	Changes
03-May-2013	OM.TT	Initial release.
06-Jun-2013	COM.TW V.COM.TW V.COM.TW	Updated Table 2: Absolute maximum ratings, Figure 10: Channel current vs. gain register value and Section 8.2: Error detection mode (CFG-7). Added Figure 13, 14, 15 and 16. Minor text changes.
19-Aug-2013	M.100X.COM. 100X.COM. 100X.COM.	Updated the Title, the Features and the Description. Modified Table 4: Electrical characteristics, Updated Table 9: Example of current ranges, Table 10: Gain steps for the current range selected by REXT = 11 kW, Section 8.2: Error detection mode (CFG-7), Section 8.8: PWM counter setting and brightness register (CFG-15).

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